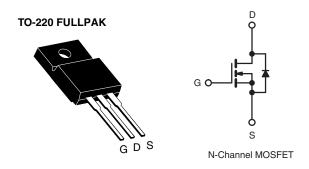


Vishay Siliconix

S Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} at T _J max. (V)	650			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.190		
Q _g max. (nC)	98			
Q _{gs} (nC)	17			
Q _{gd} (nC)	25			
Configuration	Single			



FEATURES

- · Generation one
- High E_{AR} capability
- Lower figure-of-merit R_{on} x Q_q
- 100 % avalanche tested
- Ultra low R_{on}
- dV/dt ruggedness
- Ultra low gate charge (Q_a)
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- PFC power supply stages
- · Hard switching topologies
- Solar inverters
- UPS
- Motor control
- Lighting
- Server telecom

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF22N60S-E3

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V_{DS}	600			
Gate-Source Voltage			V_{GS}	± 30	V		
Continuous Drain Current ^a	\/ -+ 10\/	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	22			
	V _{GS} at 10 V	T _C = 100 °C		13	Α		
Pulsed Drain Current b			I _{DM}	65			
Linear Derating Factor				2	W/°C		
Single Pulse Avalanche Energy ^c			E _{AS}	690	- mJ		
Repetitive Avalanche Energy ^b			E _{AR}	25			
Maximum Power Dissipation			P_{D}	250	W		
Drain-Source Voltage Slope	$T_{J} = 1$	125 °C	dV/dt	37	V/ns		
Reverse Diode dV/dt ^e			αν/αι	5.3			
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C		
Soldering Recommendations (Peak Temperature) d	for	10 s		300]		

Notes

- a. Limited by maximum junction temperature.
- b. Repetitive rating; pulse width limited by maximum junction temperature.
- c. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.
- d. 1.6 mm from case.
- e. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R_{thJA}	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.4		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	600	-	-	٧	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	2.0	-	4.0	V	
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zava Cata Valtaga Dvain Cuwant	I _{DSS}	V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	5	μΑ
Zero Gate Voltage Drain Current		V _{DS} = 600 V	-	-	100		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.160	0.190	Ω
Forward Transconductance a	9 _{fs}	V _{DS} = 50 V, I _D = 13 A		-	9.4	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}$		-	2810	-	pF
Output Capacitance	C _{oss}			-	1480	-	
Reverse Transfer Capacitance	C _{rss}			-	33	-	
Effective Output Capacitance (Time Related)	C _{oss eff.} (TR) ^a	$V_{GS} = 0 V$ $V_{DS} = 0 V$	V _{DS} = 0 V to 480 V	-	155	-	
Total Gate Charge	Q _g			-	75	110	
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V	$I_D = 22 \text{ A}, V_{DS} = 480 \text{ V}$	-	17	-	nC
Gate-Drain Charge	Q _{gd}			-	25	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 380 \text{ V}, I_{D} = 22 \text{ A},$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	24	50	- ns
Rise Time	t _r			-	68	100	
Turn-Off Delay Time	t _{d(off)}			-	77	115	
Fall Time	t _f			-	59	90	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.65	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	А
Pulsed Diode Forward Current	I _{SM}			-	-	88	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 22 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S , dI/dt = 100 A/μs, V _R = 25 V		-	462	690	ns
Reverse Recovery Charge	Q_{rr}			-	8.3	16	μC
Reverse Recovery Current	I _{RRM}			-	30	60	Α

Note

a. $C_{oss\ eff.}$ (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

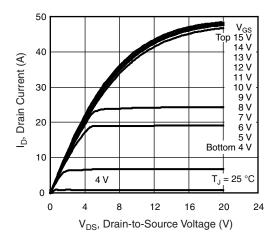


Fig. 1 - Typical Output Characteristics, T_J = 25 °C

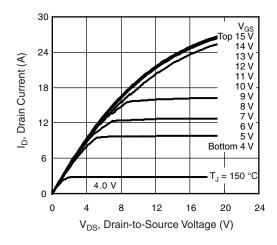


Fig. 2 - Typical Output Characteristics, T_J = 150 °C

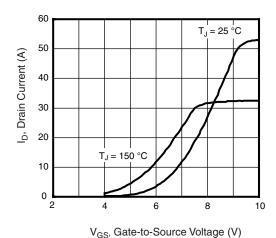


Fig. 3 - Typical Transfer Characteristics

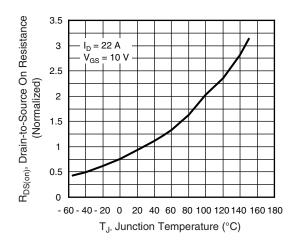


Fig. 4 - Normalized On-Resistance vs. Temperature

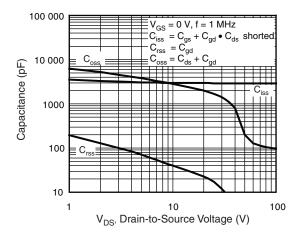


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

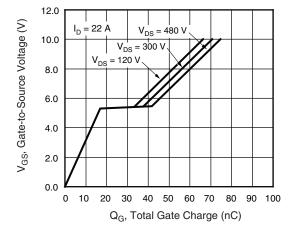


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



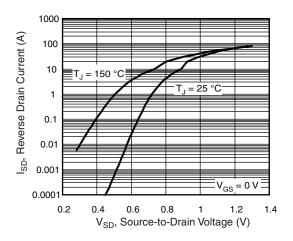


Fig. 7 - Typical Source-Drain Diode Forward Voltage

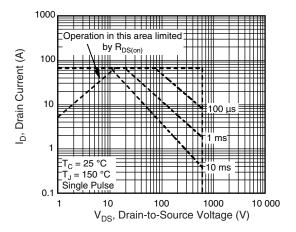


Fig. 8 - Maximum Safe Operating Area

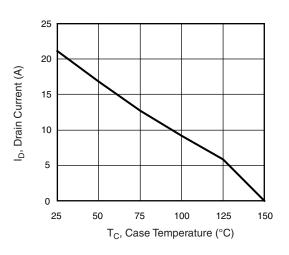


Fig. 9 - Maximum Drain Current vs. Case Temperature

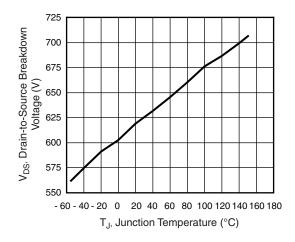


Fig. 10 - Drain-to-Source Breakdown Voltage

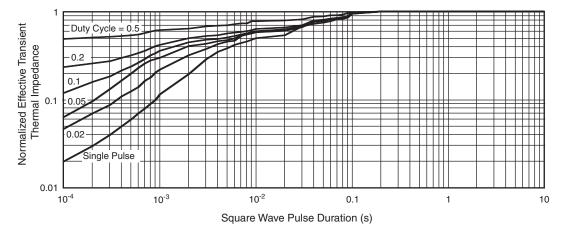


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



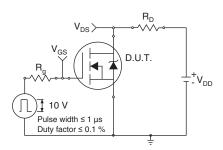


Fig. 12 - Switching Time Test Circuit

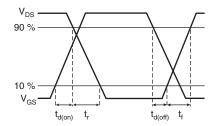


Fig. 13 - Switching Time Waveforms

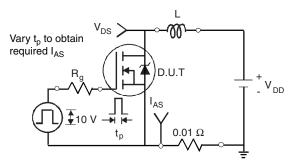


Fig. 14 - Unclamped Inductive Test Circuit

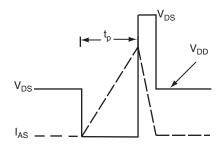


Fig. 15 - Unclamped Inductive Waveforms

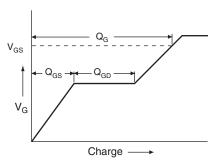


Fig. 16 - Basic Gate Charge Waveform

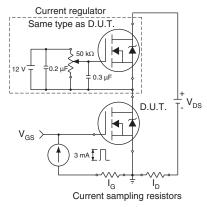
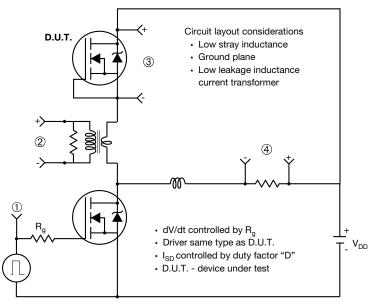


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



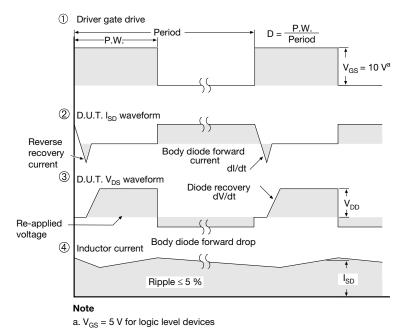


Fig. 18 - For N-Channel

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Revision: 13-Jun-16 1 Document Number: 91000